

Technical Data Sheet

TSE3282-G

PRODUCT DESCRIPTION

TSE3282-G is a one-component, heat curable (addition cure) silicone adhesive designed for thermal conductive applications. TSE3282-G adheres well to a variety of substrates, such as metals, plastics, ceramics and glass without the use of a primer.

Key Performance Properties

- Ready to use one component
- Excellent thermal conductivity
- Flowable
- Heat accelerated cure
- Excellent primerless adhesion to many substrates plastics, metals, ceramics and glass
- Non-corrosive to metals

Application

Sealing and bonding for thermal conductive applications like bonding of regulators, rectifiers and thyristors.

Typical Product Data

Uncured Properties			TSE 3282-G	
Appearance			Grey, flowable paste	
Viscosity	(@ 23°C)	Pa∙s	20	

Cured Properties	(1h @ 150°C)		
Appearance	Elastic rubber		
Density (@ 23°C)	g/cm ³	2.70	
Hardness	Shore A	80	
Tensile strength	MPa	4.0	
Elongation	%	50	
Adhesive strength*1	MPa	2.5	
Thermal expansion coefficient*2	1/K	1.4 · 10 ⁻⁴	
Thermal conductivity*3	W/m⋅K	2.0	
Volume resistivity	ohm · cm	4.8 · 10 ¹⁴	
Dielectric strength	kV/mm	23	
Dielectric constant (60Hz)	5.5		
Dielectric loss (60Hz)	0.001		
Useful Temperature Range,°C	-50 to 200		

^{*1} Aluminium Lap shear

^{*2} GETOS standard test method

^{*3} Kyoto Electronics Manufacturing, Quick Thermal Conductivity Meter QTM-500





Specifications

Typical product data values should not be used as specification. Assistance and specifications are available by contacting Momentive performance materials Technical Service RTV1 and RTV2.

Instructions for Use

Compatibility

TSE3282-G thermal conductive silicone adhesive will cure in contact with most clean, dry surfaces. However, certain materials, such as butyl and chlorinated rubber, sulfur-containing materials, amines, and certain metal soap cured RTV silicone rubber compounds can cause cure inhibition. Cure inhibition is characterized by a greasy appearance of the TSE3282-G adhesive at the interface between the adhesive and the substrate to be bonded. It is recommended that a sample patch test should be performed with the TSE3282-G silicone adhesive to determine substrate compatibility.

Surface Preparation

The adhesive performance of any polymer system is highly dependent upon proper surface preparation. In order to maximize the adhesion of TSE3282-G and minimize the potential for cure inhibition, all parts should be as clean and dry as possible prior to the application of the adhesive.

Bonding

TSE3282-G thermal conductive adhesive offers outstanding adhesion characteristics to a wide variety of different substrates without the need of a primer. For difficult-to-bond-to substrates, or where more aggressive chemical adhesion is desired, using SS4155 silicone primer, available from Momentive performance materials, may enhance the adhesion. To apply the primer, thoroughly clean the surface and let dry. Then apply a uniform film (0.01-0.02 mm) of SS4155 silicone primer and allow the primer to air-dry for one hour or more.

Curing

TSE3282-G thermal conductive adhesive requires the use of elevated temperatures in order to achieve full cure. Typical cure times and temperatures are as follows:

100°C - 90 minutes 125°C - 45 minutes 150°C - 30 minutes

The actual cure time is affected by such things as cross-sectional thickness of the TSE3282-G adhesive, heat capacity of the overall assembly and efficiency and type of oven used (i.e. convection, infrared).

Handling and Safety

Material Safety Data Sheets are available upon request from Momentive performance materials. Similar information for solvents and other chemicals used with the Momentive performance materials products should be obtained from your supplier. When solvents are used, proper safety precautions must be observed.

Storage and Warranty Period

The shelf life will be indicated by the use before date on the associated documents with a minimum of 3 months when stored in the original unopened containers between 2 and 10 C.

Availability

TSE3282-G is available in 200 g tubes and 1kg cans.





PRINCIPAL LOCATIONS - Regional Information

North America	World Headquarters 187 Danbury Road Wilton, CT 06897, USA	T 800.295.2392	F 607.754.7517
Latin America	Rodovia Eng. Constâncio Cintra, Km 78,5 Itatiba, SP – 13255-700, Brazil	T +55.11.4534.9650	F +55.11.4534.9660
Europe, Middle East, Africa and India	D-51368 Leverkusen Germany	T 00.800.4321.1000 T +31.164.293.276	F +31.164.241.750
Pacific	Akasaka Park Building - 5-2-20 Akasaka Minato-ku, Tokyo 107-6112 Japan	T +81.3.5544.3100	F +81.3.5544.3101
CUSTOMER SERVICE	E CENTERS		
North America	Charleston, WV 25314, USA E cs-na.silicones@momentive.com		
	Specialty FluidsUA, Silanes, Resins, and Specialties	T 800.523.5862 T 800.334.4674	F 304.746.1654 F 304.746.1623
	RTV Products-ElastomersSealants and Adhesives & Construction	T 800.332.3390 T 877.943.7325	F 304.746.1623 F 304.746.1654
Latin America	E cs-la.silicones@momentive.com		
Latin America	 Argentina & Chile Brazil Mexico & Central America Venezuela, Ecuador, Peru, Colombia, & Caribbean 	T +54.11.4862.9544 T +55.11.4534.9650 T +52.55.5899.5135 T +58.212.285.2149	F +54.11.4862.9544 F +55.11.4534.9660 F +52.55.5899.5138 F +58.212.285.2149
Europe, Middle East, Africa and India	E cs-eur.silicones@momentive.com	T 00.800.4321.1000 T +31.164.293.276	F +31.164.241750
Pacific	E cs-ap.silicones@momentive.com Japan China Korea Singapore	T +81.276.20.6182 T +86.21.5050.4666 (ext. 1523) T +82.2.6201.4600 T +65.6220.7022	
Worldwide Hotline	Worldwide Web www.momentive.com	T 800.295.2392 T +607.786.8131	F +607.786.8309

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